

**Selçuk Köse**

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**Research Interests**

- **Research interests:** On-chip voltage regulation; Power management; 3-D integration; Hardware security; Green computing

**Education**

- **University of Rochester** Rochester, NY  
*Doctor of Philosophy in Electrical and Computer Engineering* March 2008 - June 2012  
**Dissertation:** High Performance Power Delivery in Nanoscale Integrated Circuits
- **University of Rochester** Rochester, NY  
*Master of Science in Electrical and Computer Engineering* September 2006 - March 2008
- **Bilkent University** Ankara, Turkey  
*Bachelor of Science in Electrical and Electronics Engineering* September 2001 - May 2006

**Work Experience**

- **University of South Florida** Tampa, FL  
*Assistant Professor, Electrical Engineering Department* August 2012 - Current
- **University of Rochester** Rochester, NY  
*Research Assistant, High Performance Integrated Circuit Design Laboratory* September 2007 - June 2012
- **Freescale Semiconductor** Tempe, AZ  
*Graduate Intern, Microwave and Mixed-Signal Laboratory* May 2010 - August 2010
- **Eastman Kodak Company** Rochester, NY  
*Graduate Intern, CMOS Image Sensors R&D Laboratory* May 2009 - June 2009
- **Intel Corporation** Santa Clara, CA  
*Graduate Intern, Central Technology and Special Circuits Team* May 2008 - August 2008
- **Intel Corporation** Santa Clara, CA  
*Graduate Intern, Central Technology and Special Circuits Team* May 2007 - August 2007
- **The Scientific and Technological Research Council of Turkey** Ankara, Turkey  
*Part-Time Engineer, VLSI Design Center* March 2006 - June 2006
- **Nanomagnetics Instruments** Ankara, Turkey  
*Technical Intern* June 2005 - August 2005

**Awards**

- National Science Foundation CAREER Award, 2014
- Türkiye İis Bankası *Golden Youth Award* for outstanding success in University Entrance Exam  
12<sup>th</sup> over 1.5 million candidates, Turkey, 2001
- Full scholarship and stipend awarded by Bilkent University, Ankara, Turkey, 2001-2006
- Awarded with Abroad Undergraduate Education Fellowship by Turkish Government, Turkey, 2001

## Publications

### Book

- B1. R. Jakushokas, M. Popovich, A. V. Mezhiba, **S. Köse**, and E. G. Friedman, *Power Distribution Networks with On-Chip Decoupling Capacitors, Second Edition*, Springer, 2011.

### Journals

- J1. I. Vaisband, M. Azhar, E. G. Friedman and **S. Köse**, “Digitally Controlled Pulse Width Modulator for On-Chip Power Management,” *IEEE Transactions on Very Large Scale Integration (VLSI) Circuits*, (in press).
- J2. O. Uzun and **S. Köse**, “Converter-Gating: A Power Efficient and Secure On-Chip Power Delivery System,” *IEEE Journal on Emerging and Selected Topics in Circuits and Systems*, Vol. 4, No. 2, pp. 169 - 179, June 2014.
- J3. **S. Köse**, S. Tam, S. Pinzon, B. McDermott, and E. G. Friedman, “Active Filter Based Hybrid On-Chip DC-DC Converters for Point-of-Load Voltage Regulation,” *IEEE Transactions on Very Large Scale Integration (VLSI) Circuits*, Vol. 21, No. 4, pp. 680 - 691, April 2013.
- J4. I. Savidis, **S. Köse**, and E. G. Friedman, “Power Noise in TSV-Based 3-D Integrated Circuits,” *IEEE Journal of Solid-State Circuits*, Vol. 48, No. 2, pp. 587 - 597, February 2013.
- J5. **S. Köse** and E. G. Friedman, “Distributed On-Chip Power Delivery,” *IEEE Journal on Emerging and Selected Topics in Circuits and Systems*, Vol. 4, No. 4, pp. 704 - 713, December 2012.
- J6. **S. Köse** and E. G. Friedman, “Efficient Algorithms for Fast IR Drop Analysis Exploiting Locality,” *Integration, the VLSI Journal*, Vol. 45, No. 2, pp. 149 - 161, March 2012.
- J7. **S. Köse** and E. G. Friedman, “Effective Resistance of a Two Layer Mesh,” *IEEE Transactions on Circuits and Systems II: Express Briefs*, Vol. 58, No. 11, pp. 739 - 743, November 2011.
- J8. **S. Köse**, E. Salman, and E. G. Friedman, “Shielding Methodologies in the Presence of Power/Ground Noise,” *IEEE Transactions on Very Large Scale Integration (VLSI) Circuits*, Vol. 19, No. 8, pp. 1458 - 1468, August 2011.

### Conferences

- C1. O. Uzun and **S. Köse**, “Workload Aware Regulator-Gating Methodology With Distributed Switched Capacitor Voltage Converters,” *Proceedings of the IEEE Computer Society Annual Symposium on VLSI*, July 2014.
- C2. **S. Köse**, “Thermal Implications of On-Chip Voltage Regulation: Upcoming Challenges and Possible Solutions,” *Proceedings of the IEEE/ACM Design Automation Conference (DAC)*, June 2014.
- C3. M. Azhar and **S. Köse**, “An Enhanced Pulse Width Modulator with Adaptive Duty Cycle and Frequency Control,” *Proceedings of the IEEE International Symposium on Circuits and Systems*, June 2014.
- C4. **S. Köse**, “Regulator-Gating: Adaptive Management of On-Chip Voltage Regulators,” *Proceedings of the ACM/IEEE Great Lakes Symposium on VLSI*, pp. 105 - 110, May 2014.

- C5. **S. Köse**, I. Vaisband, and E. G. Friedman, “Digitally Controlled Wide Range Pulse Width Modulator for on-Chip Power Supplies,” *Proceedings of the IEEE International Symposium on Circuits and Systems*, pp. 2251 - 2254, May 2013.
- C6. **S. Köse**, R. M. Secareanu, O. Hartin, and E. G. Friedman, “Current Profile of a Microcontroller to Determine Electromagnetic Emissions” *Proceedings of the IEEE International Symposium on Circuits and Systems*, pp. 2650 - 2653, May 2013.
- C7. **S. Köse** and E. G. Friedman, “Distributed Power Delivery for Energy Efficient and Low Power Systems,” *Asilomar Conference on Signals, Systems, and Computers*, November 2012, **(invited paper)**.
- C8. **S. Köse** and E. G. Friedman, “Design Methodology to Distribute On-Chip Power in Next Generation Integrated Circuits,” *IEEE 27-th Convention of Electrical and Electronics Engineers in Israel*, November 2012, **(invited paper)**.
- C9. **S. Köse** and E. G. Friedman, “Power Delivery in Heterogeneous Integrated Circuits,” *IEEE CAS-FEST Workshop (in conjunction with ISCAS2012)*, May 2012, **(invited talk)**.
- C10. **S. Köse**, S. Tam, S. Pinzon, B. McDermott, and E. G. Friedman, “An Area Efficient On-Chip Hybrid Voltage Regulator,” *Proceedings of the IEEE International Symposium on Quality Electronic Design (ISQED)*, pp. 398-403, March 2012.
- C11. **S. Köse** and E. G. Friedman, “Fast Algorithms for IR Voltage Drop Analysis Exploiting Locality,” *Proceedings of the IEEE/ACM Design Automation Conference (DAC)*, pp. 996-1001, June 2011.
- C12. **S. Köse** and E. G. Friedman, “Distributed Power Network Co-Design with On-Chip Power Supplies and Decoupling Capacitors,” *Proceedings of the ACM/IEEE International Workshop on System Level Interconnect Prediction (SLIP)*, June 2011.
- C13. I. Savidis, **S. Köse**, and E. G. Friedman, “Power Grid Noise in TSV-Based 3-D Integrated Systems,” *Government Microcircuit Applications and Critical Technology Conference (GOMACHTech)*, pp. 129-132, March 2011.
- C14. **S. Köse** and E. G. Friedman, “Simultaneous Co-Design of Distributed On-Chip Power Supplies and Decoupling Capacitors,” *Proceedings of the IEEE International SoC Conference*, pp. 15-18, September 2010.
- C15. **S. Köse** and E. G. Friedman, “An Area Efficient Fully Monolithic Hybrid Voltage Regulator” *Proceedings of the IEEE International Symposium on Circuits and Systems*, pp. 2718-2721, May/June 2010.
- C16. **S. Köse** and E. G. Friedman, “Fast Algorithms for Power Grid Analysis Based on Effective Resistance,” *Proceedings of the IEEE International Symposium on Circuits and Systems*, pp. 3661-3664, May/June 2010.
- C17. **S. Köse** and E. G. Friedman, “On-Chip Point-of-Load Voltage Regulator for Distributed Power Supplies,” *Proceedings of the ACM/IEEE Great Lakes Symposium on VLSI*, pp. 377-380, May 2010.
- C18. **S. Köse**, E. Salman, and E. G. Friedman, “Shielding Methodologies in the Presence of Power/Ground Noise,” *Proceedings of the IEEE International Symposium on Circuits and Systems*, pp. 2277-2280, May 2009.
- C19. **S. Köse**, E. Salman, Z. Ignjatovic, and E. G. Friedman, “Pseudo-Random Clocking to Enhance Signal Integrity,” *Proceedings of the IEEE International SoC Conference*, pp. 47-50, September 2008.

## Workshop Presentations

W1. I. Vaisband, **S. Köse**, I. Savidis, and E. G. Friedman, “On-Chip Power Delivery,” University Technology Showcase, Rochester, New York, April 6, 2011.

## Patents

P1. **S. Köse** and E. G. Friedman, “A Digitally Controlled Wide Range Pulse Width Modulator,” US patent application filed September 2012.

## Invited Talks

- Design of Efficient and Trustworthy On-Chip Power Delivery Systems, Workshop on Energy-Secure System Architectures (ESSA) (In Conjunction with ISCA’14), Minneapolis, Minnesota, June 2014.
- Converter-Gating: An Efficient On-Chip Power Delivery Architecture, Intel Corporation, Santa Clara, California, June 2014.
- Converter-Gating: An Efficient On-Chip Power Delivery Architecture, Synaptics Austin Design Center, Austin, Texas, May 2014.
- Distributed On-Chip Power Delivery – On-going Research and New Directions, IBM T. J. Watson Research Center, Yorktown Heights, New York, April 2013.
- Distributed Power Delivery for Energy Efficiency and Low Power Systems, Asilomar Conference on Signals, Systems, and Computers, Monterey, California, November 2012.
- High Performance Power Delivery for Nanoscale Integrated Circuits, University of South Florida, Tampa, Florida, February 2012.
- EMMA: A Methodology to Model Current Activity of a Digital Block to Determine Emission Level for a Broad Frequency Range, *RF, Analog, and Sensor Group*, Freescale Semiconductor, Tempe, Arizona, August 2010.
- Simultaneous Co-Design of Clock and Power Distribution Networks, *Central Technology and Special Circuits Team*, Intel Corporation, Santa Clara, California, March 2009.
- Un-Core Clock Distribution of Nehalem-Ex Processor and the De-Skew Machine Operation Principles, *Central Technology and Special Circuits Team*, Intel Corporation, Santa Clara, California, August 2007.

## Teaching

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| <ul style="list-style-type: none"> <li>• <b>Instructor</b><br/>Design II (Senior Design Project)<br/>High Performance Integrated Circuit Design<br/>Introduction to Electrical Systems I (EGN 3373)</li> </ul> | University of South Florida<br>Spring 2014, 54 students<br>Fall 2013, 8 students<br>Fall 2012, > 120 students |
| <ul style="list-style-type: none"> <li>• <b>Co-Lecturer</b><br/>Performance Issues in IC/VLSI Design and Analysis</li> </ul>   | University of Rochester<br>Fall 2011, > 10 students   |
| <ul style="list-style-type: none"> <li>• <b>Teaching Assistant</b><br/>VLSI Design Methodologies<br/>Circuits and Signals<br/>Introduction to Signals and Circuits</li> </ul>                                  | University of Rochester<br>Fall 2009, > 10 students<br>Fall 2006, > 30 students<br>Spring 2007, > 35 students |

- **Teaching Assistant**

Analog Electronics

Microprocessors

Bilkent University, Ankara

Fall 2004, Fall 2005, > 100 students

Spring 2005, Spring 2006 > 100 students

## Grants

- National Science Foundation CAREER award "Regulator-Gating (ReGa): A New On-Chip Power Delivery Architecture." \$450,000. (PI)

2014–2019

## Professional Activities

- Associate editor  
*Journal of Circuits, Systems, and Computers (JCSC)*, 2012 – present  
*Microelectronics Journal*, 2014 – present
- Technical program committee member  
ACM Great Lakes Symposium on VLSI, 2013 – 2014  
IEEE Computer Society Annual Symposium on VLSI, 2014
- Local arrangement chair  
IEEE Computer Society Annual Symposium on VLSI, 2014
- External reviewer  
Journals: *IEEE Journal of Solid-State Circuits (JSSC)*, *IEEE Transactions on Power Electronics (TPEL)*, *ACM Computing Surveys*, *IEEE Journal on Emerging and Selected Topics in Circuits and Systems (JETCAS)*, *IEEE Transactions on Very Large Scale Integration (VLSI) Circuits (TVLSI)*, *IEEE Transactions Circuits and Systems-I (TCAS-I)*, *IEEE Transactions Circuits and Systems-II (TCAS-II)*, *IEEE Transactions Computer-Aided Design (TCAD)*, *IEEE Electron Device Letters (EDL)*, *ASP Journal of Low Power Electronics (JOLPE)*, *Analog Integrated Circuits and Signal Processing, Integration, the VLSI Journal*, *IET Circuits, Devices & Systems*, *Microelectronics Journal*.  
Conferences: International Conference on Computer-Aided Design (ICCAD), International Symposium on Quality Electronic Design (ISQED), Design, Automation and Test in Europa (DATE), International Conference on Circuits and Systems (ISCAS), International Conference on Computer Design (ICCD), System-on-Chip Conference (SOCC), Asia Pacific Conference on Circuits and Systems (APCCAS), International Workshop on Power And Timing Modeling, Optimization and Simulation (PATMOS), Asia Symposium on Quality Electronic Design (ASQED), International Symposium on Networks-on-Chip (NOCS), Great Lakes Symposium on VLSI (GLSVLSI), International Conference on Very Large Scale Integration (VLSI-SOC).

## Service

### Government

- Participant at the "CCC/SIGDA Workshop on Extreme Scale Design Automation" visioning workshop (invitation only), organized by ACM special interest group on design automation (ACM/SIGDA), 02/21-22/2014.
- NSF Panelist, 2014.

### University of South Florida

- Electrical Engineering Student Success Committee, Fall'12 –present.